HCSA1V1008

Automotive grade dual winding high current inductor





Product features

- · AEC-Q200 qualified
- · Magnetically shielded, low EMI
- Robust molded construction
- · Dual winding, ideal for SEPIC converters
- Inductance range from 10 μH to 22 μH
- Current range from 3.3 A to 11.2 A
- 11.35 mm x 10.3 mm footprint surface mount package in a 8.2 mm height
- · Moisture sensitivity level (MSL): 1
- · Alloy powder core material

Applications

- · Body electronics
 - Heating ventilation and air conditioning controllers (HVAC)
 - Headlamps, tail lamps and interior lighting and LED lighting
 - · Doors, window lift and seat control
- Advanced driver assistance systems
 - Basic and smart surround, and rear and frontview camera
 - Adaptive cruise control (ACC)
 - · Collision avoidance system
 - · Car black box system
- · Infotainment and cluster electronics
 - Audio subsystem: head unit and trunk amp
 - · Digital instrument cluster
 - In-vehicle infotainment (IVI) and navigation
- · Engine and powertrain systems
 - Diesel/gasoline engine management
 - Powertrain control module (PCM)/ engine control unit (ECU)
 - Transmission control unit (TCU)

Environmental compliance and general specifications

- Storage temperature range (Component):
 -55 °C to +155 °C
- Operating temperature range: -55 °C to +155 °C (ambient plus self-temperature rise)
- Solder reflow temperature:
 J-STD-020 (latest revision) compliant









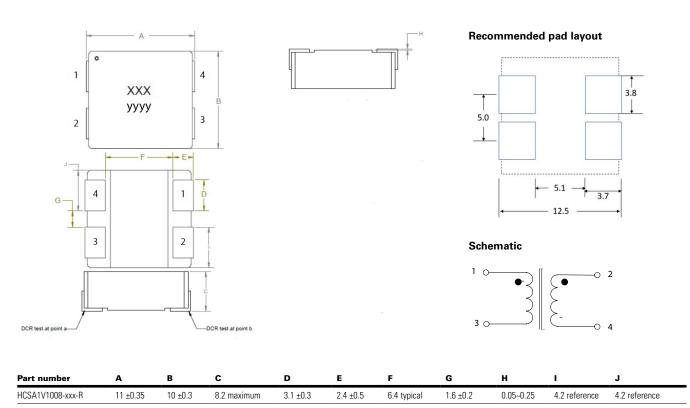
Product specifications

Part number ⁷	OCL¹ (µH) ± 20%	FLL² (µH) minimum	I _{rms} ³ (A) maximum	I _{sat} 4 (A) maximum	DCR (mΩ) typical @ +20 °C	DCR (mΩ) maximum @ +20 °C	Coupling coefficient (K)	SCL (µH) typical⁵	SRF (MHz) typical	K-factor ⁶
HCSA1V1008-100-R	10	5.6	5.0	11.2	35.80	40.45	0.95	0.30	8.4	39
HCSA1V1008-150-R	15	8.4	3.8	9.1	58.37	65.96	0.95	0.35	7.0	29
HCSA1V1008-220-R	22	12.3	3.32	7.5	74.40	84.07	0.96	0.35	5.0	25

- 1. Open Circuit Inductance (OCL) Test Parameters: 100 kHz, 0.25 V_{max} , 0.0 Adc, +25 °C, pins (1 3), (2 4) 2. Full Load Inductance (FLL) Test Parameters: 100 kHz, 0.25 V_{max} , v_{max} , +25 °C, pins (1 3), (2 4) 3. v_{max} , DC current for an approximate temperature rise of 30 °C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed +155 °C under worst case operating conditions verified in the end application.
- 4. I_{sat} : Peak current for approximately 30% rolloff @ +25 °C, pins: (1 3), (2 4)

- 5. Short circuit inductance (SCL) test parametrs: 100 kHzs, 0.25 Vrms, 0.0 Adc, pins: (1 3) short pins (2 4)
- 6. K-factor: Used to determine $B_{o,o}$ for core loss (see graph). $Bp-p = K * L * \Delta I. B_{o,o}$. (Gauss), K: (K-factor from table),
- L: (Inductance in μH), ΔI (Peak to peak ripple current in Amps).
- 7. Part Number Definition: HCSA1V1008-xxx-R
- HCSA1V1008 = Product code and size
- xxx= inductance value in µH, R= decimal point,
- If no R is present then last character equals number of zeros
- -R suffix = RoHS compliant

Dimensions- mm



Part marking: xxx= inductance value in μ H, R= decimal point, If no R is present then last character equals number of zeros

yyyy= lot code
All soldering surfaces to be coplanar within 0.1 millimeters Tolerances are ±0.3 millimeters unless stated otherwise

Pad layout tolerances are ±0.1 millimeters unless stated otherwise

DCR is measured from point "a" to point "b"

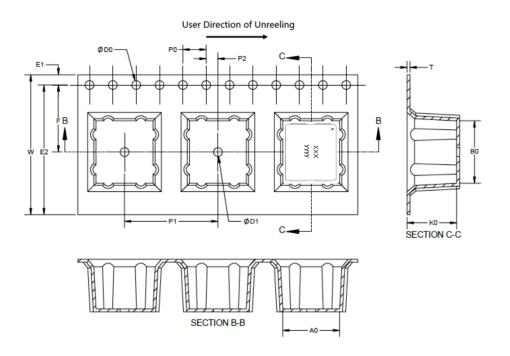
Traces or vias underneath the inductor is not recommended

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Packaging information- mm

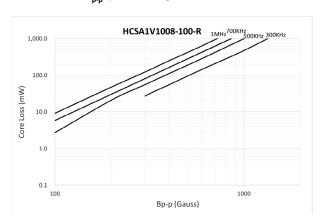
Drawing not to scale

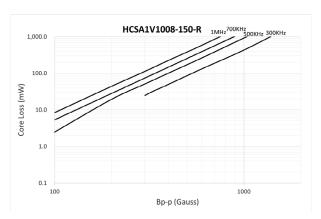
Supplied in tape and reel packaging, 400 parts per 13" diameter reel (EIA-481 compliant)

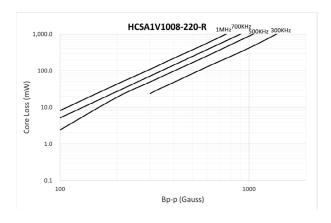


Dimension	Value		
W	24 ± 0.3		
F	11.50 ± 0.1		
E1	1.75 ± 0.1		
E2	22.25 min		
P0	4.0 ± 0.1		
P1	16.0 ± 0.1		
P2	2.0 ± 0.05		
D0	1.5 +0.1 -0		
D1	1.5 +0.1 -0		
A0	10.7 ± 0.1		
B0	11.65 ± 0.1		
K0	8.50 ± 0.1		
Т	0.5 ± 0.05		

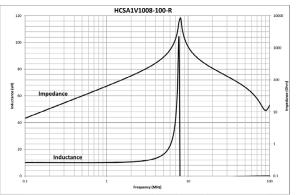
Core loss vs B_{p-p} (per winding)

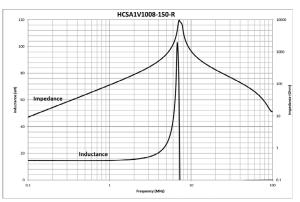


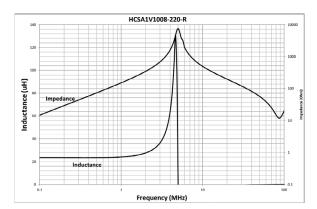




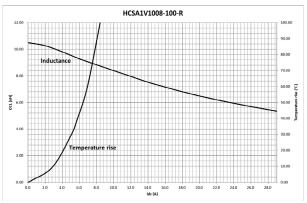
Inductance and impedance vs. frequency (per winding)

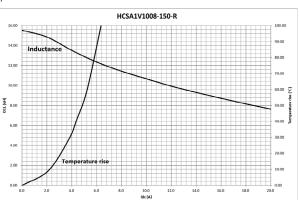


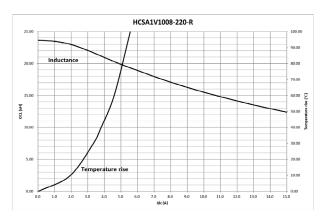




Inductance and temperature rise vs. current (per winding)







Solder reflow profile

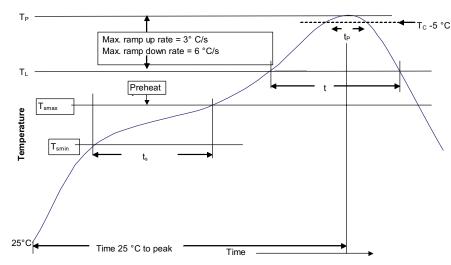


Table 1 - Standard SnPb solder (T_C)

Package thickness	Volume mm3 <350	Volume mm3 ≥350		
<2.5 mm)	235 °C	220 °C		
≥2.5 mm	220 °C	220 °C		

Table 2 - Lead (Pb) free solder (T_C)

Package thickness	Volume mm³ <350	Volume mm³ 350 - 2000	Volume mm³ >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 – 2.5 mm	260 °C	250 °C	245 °C
>2.5 mm	250 °C	245 °C	245 °C

Reference J-STD-020

Profile feature	Standard SnPb solder	Lead (Pb) free solder	
Preheat and soak • Temperature min. (T _{smin})	100 °C	150 °C	
• Temperature max. (T _{smax})	150 °C	200 °C	
• Time (T _{Smin} to T _{Smax}) (t _S)	60-120 seconds	60-120 seconds	
Ramp up rate T_L to T_p	3 °C/ second max.	3 °C/ second max.	
Liquidous temperature (T_L) Time (t_L) maintained above T_L	183 °C 60-150 seconds	217 °C 60-150 seconds	
Peak package body temperature (T _P)*	Table 1	Table 2	
Time (t _p)* within 5 °C of the specified classification temperature (T _c)	20 seconds*	30 seconds*	
Ramp-down rate (Tp to TL)	6 °C/ second max.	6 °C/ second max.	
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.	

 $^{^{\}star}$ Tolerance for peak profile temperature (Tp) is defined as a supplier minimum and a user maximum.

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